LINEAR TECHNOLOGY

Single and Dual Micropower High Side Switch Controllers in SOT-23

FEATURES

- **No External Components Required**
- **Internal Voltage Triplers Produce High Side Gate Drive for Logic Level FETs**
- **Ultralow Power:**
  10μA Per Driver ON Current (LTC1982)
  20μA ON Current (LTC1981)
  <1μA Shutdown Current
- V_{CC} Range: 1.8V to 5V
- Gate Drive Outputs Driven to Ground During Shutdown
- Gate Drive Outputs Internally Clamped to 7.5V Max
- "Gate Drive Ready" Output (LTC1981)
- Ultrasmall Application Circuit
- 5-Pin SOT-23 Package (LTC1981)
- 6-Pin SOT-23 Package (LTC1982)

APPLICATIONS

- Cellular Telephones
- Portable POS Terminal
- Handheld Battery Powered Equipment

DESCRIPTION

The LTC®1981/LTC1982 are low-power, self-contained N-channel MOSFET drivers. An internal voltage tripler allows gates to be driven without the use of any external components. Internal regulation circuitry allows quiescent current to drop to 10μA per driver (20μA for LTC1981) once the gates are charged.

Low quiescent current and low shutdown current (under 1μA) make these parts ideal for battery and other power constrained systems. The wide input voltage range accommodates a variety of battery/input configurations.

Gate drive is internally clamped to 7.5V providing protection to the external MOSFET gate. The MOSFETs can be driven in either high side or low side mode.
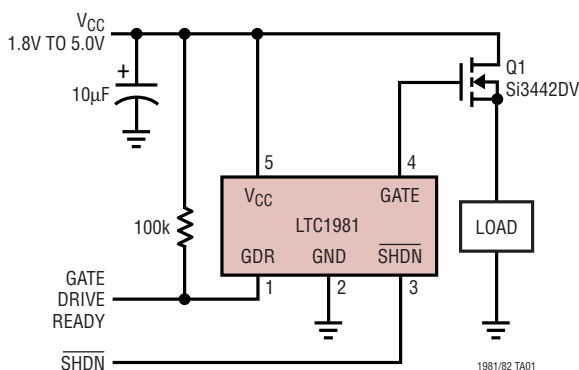
The LTC1981 single driver version also includes a gate drive ready pin and twice the drive current capacity of the dual driver LTC1982.

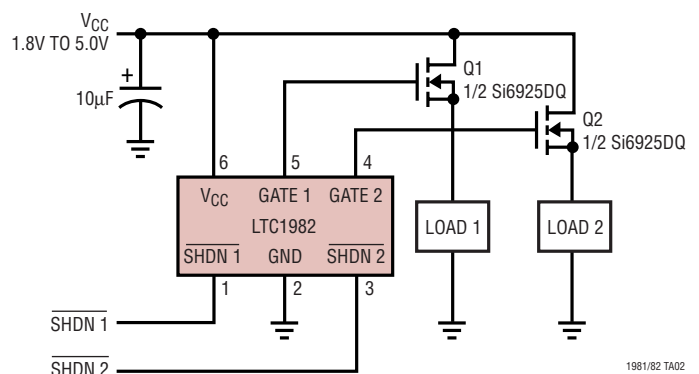The LTC1981 is available in a 5-pin SOT-23. The LTC1982 is available in a 6-pin SOT-23.

LT, LTC and LT are registered trademarks of Linear Technology Corporation.

TYPICAL APPLICATIONS

Single High Side Switch Controller

Dual High Side Switch Controller

ABSOLUTE MAXIMUM RATINGS (Notes 1, 2)

Terminal Voltage
  LTC1981: V_{CC}, GATE, $\overline{SHDN}$, GDR .... −0.3V to 7.5V
  LTC1982: V_{CC}, GATE 1, GATE 2,
        $\overline{SHDN\ 1}$, $\overline{SHDN\ 2}$ .... −0.3V to 7.5V

Operating Temperature Range
  LTC1981E/LTC1982E (Note 3) .... −40°C to 85°C
Storage Temperature Range .... −65°C to 150°C
Lead Temperature (Soldering, 10 sec) .... 300°C

PACKAGE/ORDER INFORMATION

TOP VIEW	ORDER PART NUMBER
GDR 1 ▢▢ 5 V_{CC} GND 2 ▢▢ $\overline{SHDN}$ 3 ▢▢ 4 GATE S5 PACKAGE 5-LEAD PLASTIC SOT-23 T_{JMAX} = 150°C, θ_{JA} = 250°C/W	LTC1981ES5
	S5 PART MARKING
	LTSF

TOP VIEW	ORDER PART NUMBER
$\overline{SHDN\ 1}$ 1 ▢●▢ 6 V_{CC} GND 2 ▢▢ 5 GATE 1 $\overline{SHDN\ 2}$ 3 ▢▢ 4 GATE 2 S6 PACKAGE 6-LEAD PLASTIC SOT-23 T_{JMAX} = 150°C, θ_{JA} = 230°C/W	LTC1982ES6
	S6 PART MARKING
	LTPF

Consult factory for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 5V unless otherwise specified. $C_{GATE\ 1} = C_{GATE\ 2} = C_{GATE}$ = 1000pF.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{CC}	Operating Supply Voltage		●	1.8		5.5	V
I_{CC}	Supply Current	GATE 1 and GATE 2 Outputs High GATE 1 or GATE 2 Outputs High GATE Output High (LTC1981)	● ● ●		17 10 17	30 20 30	μA μA μA
I_{SHDN}	$\overline{SHDN}$ Supply Current	$\overline{SHDN\ 1}$ and $\overline{SHDN\ 2}$ Inputs Low $\overline{SHDN}$ Input Low (LTC1981)	● ●			1 1	μA μA
V_{GATE}	GATE Drive Output Voltage	V_{CC} = 1.8V V_{CC} = 2.7V V_{CC} = 3.3V V_{CC} = 5V	● ● ● ●	4.27 6.40 6.90 6.90	4.50 6.75 7.25 7.25	4.75 7.10 7.50 7.50	V V V V
f_{OSC}	Charge Pump Oscillator Frequency	Measured with 10k Resistor from Output to GND			600		kHz
t_{ON}	Turn-on Time into 1000pF	From $\overline{SHDN\ 1}$, $\overline{SHDN\ 2}$ Going High to GATE 1, GATE 2 = V_{CC} + 1V			110		μs
		From $\overline{SHDN}$ Going High to GATE = V_{CC} +1V (LTC1981)			85		μs
t_{OFF}	Turn-off Time into 1000pF	From $\overline{SHDN\ 1}$, $\overline{SHDN\ 2}$ Going Low to GATE 1, GATE 2, GATE = 100mV			12		μs
V_{IL}	$\overline{SHDN}$ Input Low Voltage	V_{CC} = 1.8V to 5.5V	●	0.4			V
V_{IH}	$\overline{SHDN}$ Input High Voltage	V_{CC} = 1.8V to 5.5V	●			1.6	V
C_{IN}	$\overline{SHDN}$ Input Capacitance	(Note 4)			5		pF
I_{IN}	$\overline{SHDN}$ Input Leakage Current					±1	μA

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{CC} = 5V unless otherwise specified. $C_{GATE\,1}$ = $C_{GATE\,2}$ = C_{GATE} = 1000pF. (LTC1981 only)

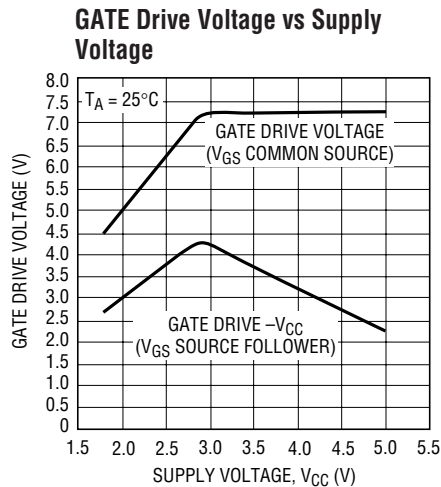| SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OL}	GDR Output Voltage Low	I_{SINK} = 100µA, V_{CC} = 1.8V	●		0.05	0.4	V
	GATE Drive Ready Trip Point	GATE Voltage Rising					
		V_{CC} = 1.8V	●	3.85	4.05	4.25	V
		V_{CC} = 2.7V	●	5.78	6.08	6.38	V
		V_{CC} = 3.3V	●	6.17	6.5	6.82	V
		V_{CC} = 5V	●	6.17	6.5	6.82	V
	GDR Hysteresis	GATE Voltage Falling			2		%
	GDR Delay	After GATE is Above the GDR Trip Threshold 10k Pull-Up to V_{CC}			2		µs

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

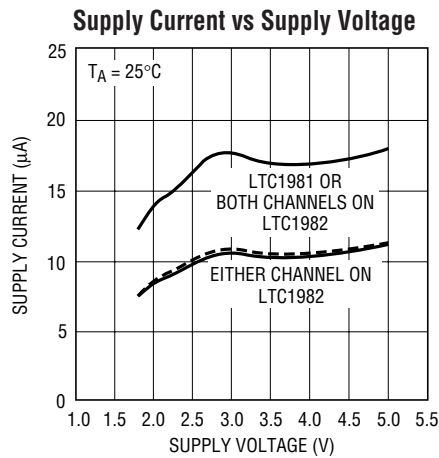**Note 2:** All voltage values are with respect to GND.

Note 3: the LTC1982E is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the −40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

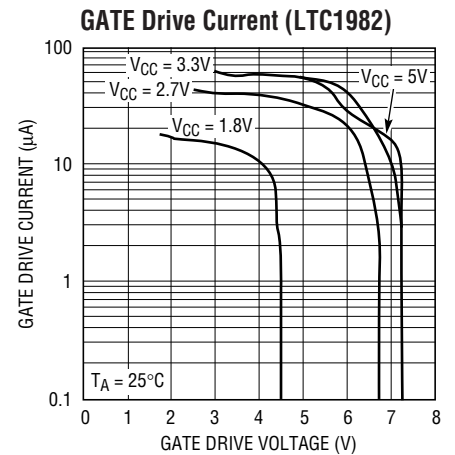**Note 4:** Guaranteed by design not subject to test.
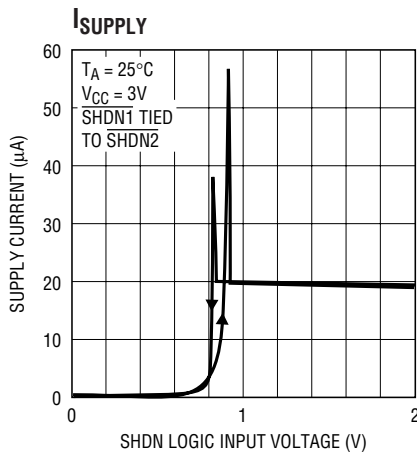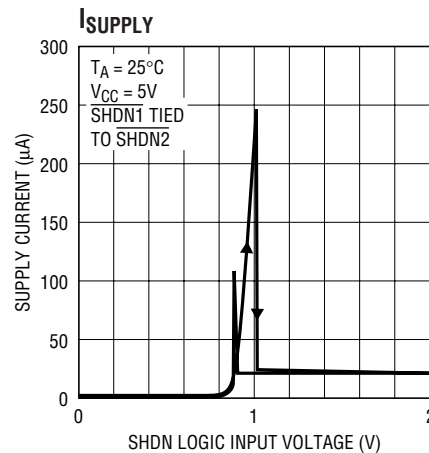
TYPICAL PERFORMANCE CHARACTERISTICS

GATE Drive Voltage vs Supply Voltage

1982 G01

Supply Current vs Supply Voltage

1982 G02

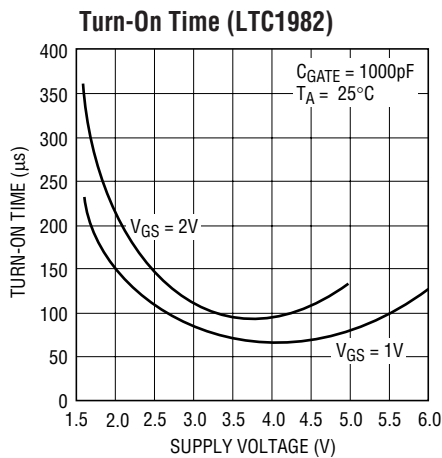### GATE Drive Current (LTC1982)

1982 G03

1981/82 G04

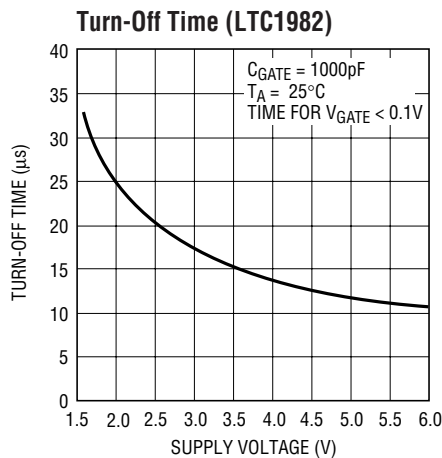

1981/82 G05

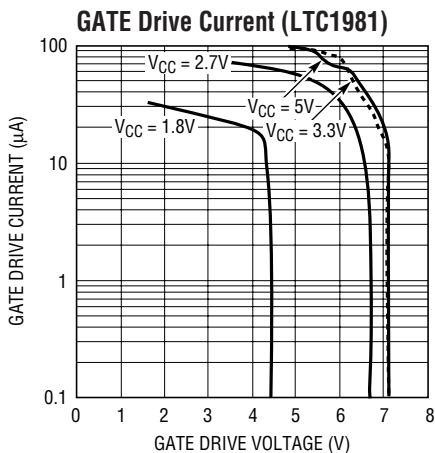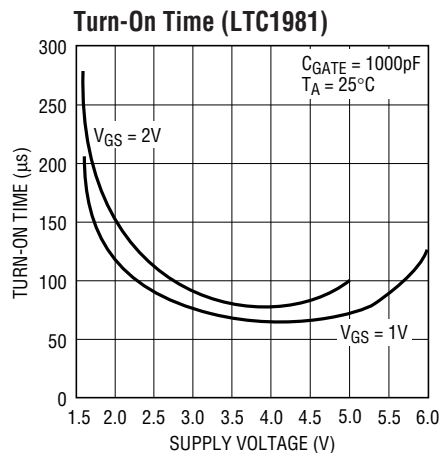# TYPICAL PERFORMANCE CHARACTERISTICS

Turn-On Time (LTC1982)

$C_{GATE} = 1000pF$
$T_A = 25°C$

$V_{GS} = 2V$

$V_{GS} = 1V$

TURN-ON TIME (µs)

SUPPLY VOLTAGE (V)

1982 G06

Turn-Off Time (LTC1982)

$C_{GATE} = 1000pF$
$T_A = 25°C$
TIME FOR $V_{GATE} < 0.1V$

TURN-OFF TIME (µs)

SUPPLY VOLTAGE (V)

1982 G07

GATE Drive Voltage vs Temperature

$V_{CC} = 3.3V$

GATE DRIVE VOLTAGE (V)

TEMPERATURE (°C)

1982 G08

GATE Drive Current (LTC1981)

$V_{CC} = 2.7V$

$V_{CC} = 5V$

$V_{CC} = 1.8V$

$V_{CC} = 3.3V$

GATE DRIVE CURRENT (µA)

GATE DRIVE VOLTAGE (V)

1981/82 G09

Turn-On Time (LTC1981)

$C_{GATE} = 1000pF$
$T_A = 25°C$

$V_{GS} = 2V$

$V_{GS} = 1V$

TURN-ON TIME (µs)

SUPPLY VOLTAGE (V)

1981/82 G10

Turn-Off Time (LTC1981)

$C_{GATE} = 1000pF$
$T_A = 25°C$
TIME FOR $V_{GATE} < 0.1$

TURN-OFF TIME (µs)

SUPPLY VOLTAGE (V)
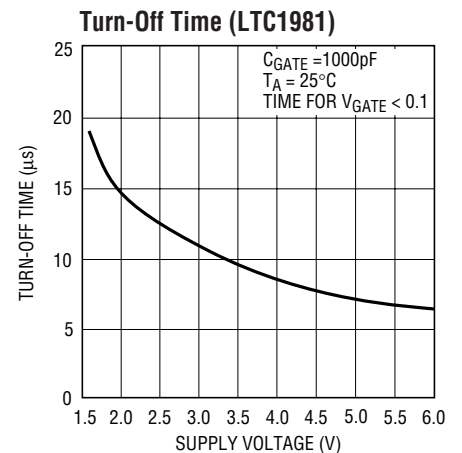
1981/82 G11

PIN FUNCTIONS

LTC1981:

GDR (Pin 1): Gate Drive Ready Active High Open Drain Output. Used to indicate when the gate drive output is greater than 90% of its final value.

GND (Pin 2): Ground.

SHDN (Pin 3): $\overline{SHDN}$ Active Low Input. Used to shut down the part and force the GATE output pin to ground.

GATE (Pin 4): Gate Drive Output to an External High Side Switch. Fully enhanced by internal charge pump. Controlled by the $\overline{SHDN}$ input pin. Output voltage on this pin will be approximately 2.5 times V_{CC} or 7.25V, whichever is less.

V_{CC} (Pin 5): Input Supply Voltage. Range from 1.8V to 5.5V.

LTC1982:

SHDN 1 (Pin 1): $\overline{SHDN\ 1}$ Active Low Input. Used to shut down the GATE 1 charge pump and force the GATE 1 output pin to ground.

GND (Pin 2): Ground.

SHDN 2 (Pin 3): $\overline{SHDN\ 2}$ Active Low Input. Used to shut down the GATE 2 charge pump and force the GATE 2 output pin to ground.

4

PIN FUNCTIONS

GATE 2(Pin 4): Gate Drive Output to an External High Side Switch. Fully enhanced by internal charge pump. Controlled by the $\overline{\text{SHDN 2}}$ input pin. Output voltage on this pin will be approximately 2.5 times V_{CC} or 7.25V, whichever is less.

GATE 1 (Pin 5): Gate Drive Output to an External High Side Switch. Fully enhanced by internal charge pump. Controlled by the $\overline{\text{SHDN 1}}$ input pin. Output voltage on this pin will be approximately 2.5 times V_{CC} or 7.25V, whichever is less.

V_{CC} (Pin 6): Input Supply Voltage. Range from 1.8V to 5.5V.

BLOCK DIAGRAMS

LTC1981 Single High Side Switch Driver

1981/82 BD01

LTC1982 Dual High Side Switch Driver

1981/82 BD02
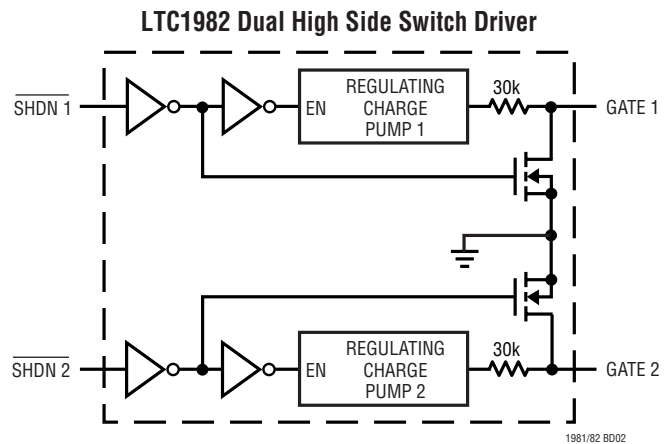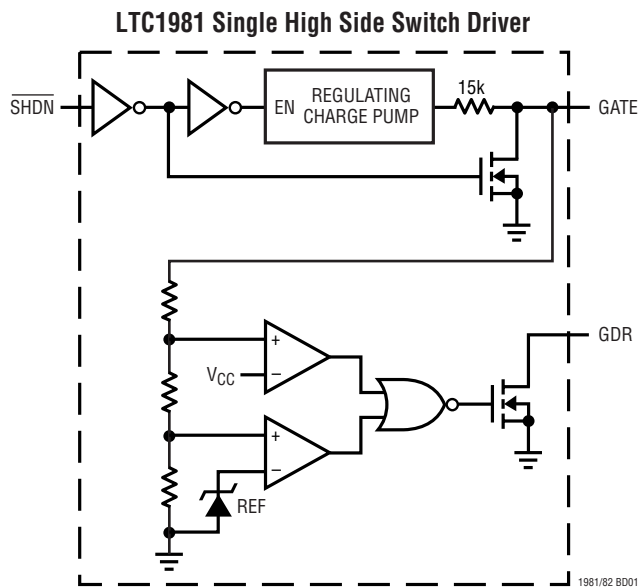
OPERATION

Charge Pump

To fully enhance the external N-channel switches, internal charge pumps are used to boost the output gate drive to approximately 2.5 times the supply voltage, or 7.25V, whichever is less. A feedback network is used to regulate the output gate drive. This keeps the supply current low in addition to providing a maximum output voltage limit. The reason for the maximum output voltage limit is to avoid switch gate source breakdown due to excessive gate overdrive.

The gate drive outputs (GATE 1, GATE 2, or GATE) are controlled by the shutdown input pins ($\overline{\text{SHDN 1}}$, $\overline{\text{SHDN 2}}$ or $\overline{\text{SHDN}}$). A logic high input on one of the shutdown input pins enables the corresponding charge pump and drives

the related gate drive output pin high. A logic low input on one of the shutdown input pins disables the corresponding charge pump and drives the related gate drive output pin low. If shutdown input on the LTC1981 is low or both of the shutdown input pins on the LTC1982 are low, the part will be placed into a low current shutdown mode (<1µA).

Gate Drive Ready (LTC1981 Only)

The gate drive ready pin (GDR) is used to indicate when the gate drive output (GATE) is greater than 90% of its final value. This can be useful in applications that require knowledge of the state of the gate drive for initialization purposes or as fault detection should something be loading the gate drive down.

APPLICATIONS INFORMATION

Logic-Level MOSFET Switches

The LTC1981/LTC1982 are designed to operate with logic-level N-channel MOSFET switches. Although there is some variation among manufacturers, logic-level MOSFET switches are typically rated with V_{GS} = 4V with a maximum continuous V_{GS} rating of ±8V. RDS (ON) and maximum V_{DS} ratings are similar to standard MOSFETs and there is generally little price differential. When operating at supply voltages of 5V or greater, care must be taken when selecting the MOSFET. The LTC1981/LTC1982 limit the output voltage to between 6.9V and 7.5V. The V_{GS} developed for the MOSFET may be too low to sufficiently turn on the MOSFET. MOSFETs rated at 2.5V, or less, will be better suited for applications where the supply voltages approach 5V.

Powering Large Capacitive Loads

Electrical subsystems in portable battery-powered equipment are typically bypassed with large filter capacitors to reduce supply transients and supply induced glitching. If not properly powered however, these capacitors may themselves become the source of supply glitching. For example, if a 100µF capacitor is powered through a switch with a slew rate of 0.1V/µs, the current during start-up is:

$$I_{START} = C(\Delta V/\Delta t)$$
$$= (100 \cdot 10^{-6})(1 \cdot 10^5)$$
$$= 10A$$

Obviously, this is too much current for the regulator (or output capacitor) to supply and the output will glitch by as much as a few volts.

The start up current can be substantially reduced by limiting the slew rate at the gate of an N-channel as shown in Figure 1. The gate drive output of the LTC1981/LTC1982 have an internal 30k resistor (15k LTC1981) in series with each of the output gate drive pins (see Functional Block Diagram). Therefore, it only needs an external 0.1µF capacitor (0.22µF for the LTC1981) to create enough RC delay to substantially slow the slew rate of the MOSFET gate to approximately 0.6V/ms. Since the MOSFET is operating as a source follower, the slew rate at the source is essentially the same as that at the gate, reducing the startup current to approximately 60mA which is easily

managed by the system regulator. R1 is required to eliminate the possibility of parasitic MOSFET oscillations during switch transitions. It is a good practice to isolate the gates of paralleled MOSFETs with 1k resistors to decrease the possibility of interaction between switches.
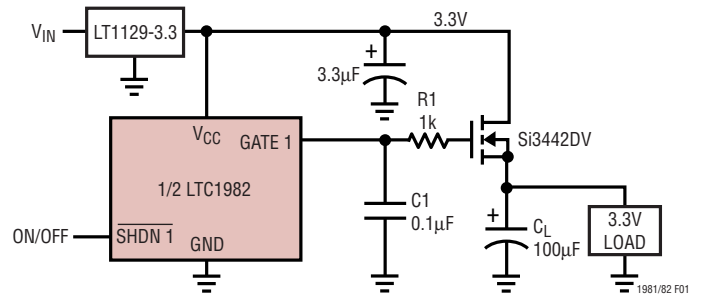

Figure 1. Powering a Large Capacitive Load

Mixed 5V/3V Systems

Because the input ESD protection diodes are referenced to the GND pin instead of the supply pin, it is possible to drive the LTC1981/LTC1982 inputs from 5V CMOS or TTL logic even though the LTC1981/LTC1982 is powered from a 3.3V supply as shown in Figure 2. Likewise, because the input threshold voltage high is never greater than 1.6V, the reverse situation is true. The LTC1981/LTC1982 can be driven with 3V CMOS or TTL even when the supply to the device is as high as 5V as shown in Figure 3.
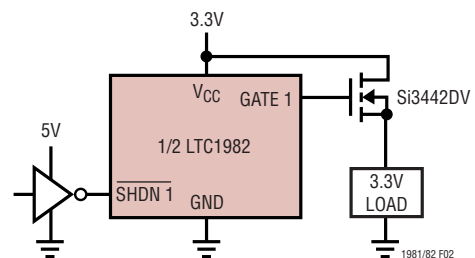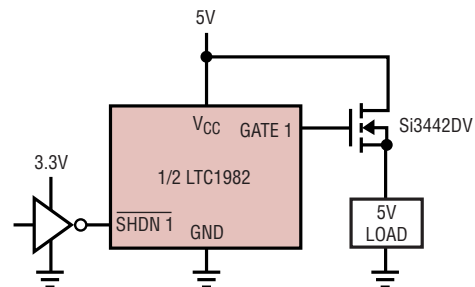

Figure 2. Direct Interface to 5V Logic

Figure 3. Direct Interface to 3.3V Logic

6

APPLICATIONS INFORMATION

Reverse Battery Protection

The LTC1981/LTC1982 can be protected against reverse battery conditions by connecting a 150Ω resistor in series with the supply pin as shown in Figure 4. The resistor limits the supply current to less than 24mA with –3.6V applied. Because the LTC1981/LTC1982 draw very little current while in normal operation, the drop across the resistor is minimal. Control logic can be protected by adding 10k resistors in series with the input pins.
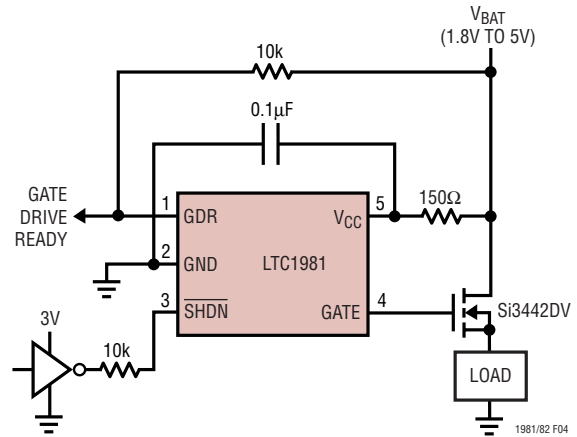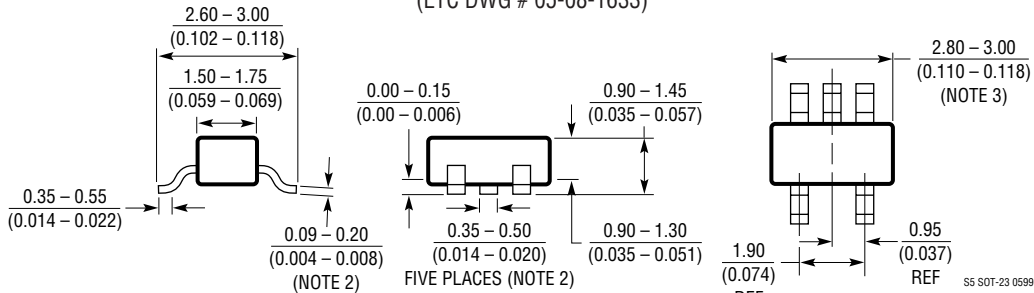

**Figure 4. Reverse Battery Protection**

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.

S5 Package
5-Lead Plastic SOT-23
(LTC DWG # 05-08-1633)

NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS ARE INCLUSIVE OF PLATING
3. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
4. MOLD FLASH SHALL NOT EXCEED 0.254mm
5. PACKAGE EIAJ REFERENCE IS SC-74A (EIAJ)

S6 Package
6-Lead Plastic SOT-23
(LTC DWG # 05-08-1634)
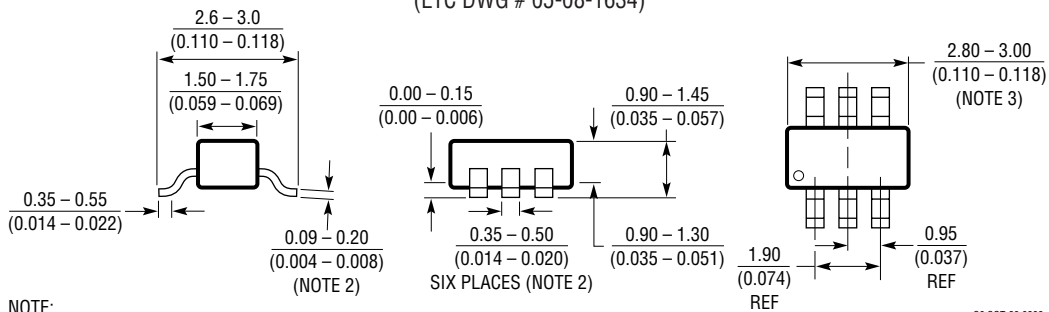
NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS ARE INCLUSIVE OF PLATING
3. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
4. MOLD FLASH SHALL NOT EXCEED 0.254mm
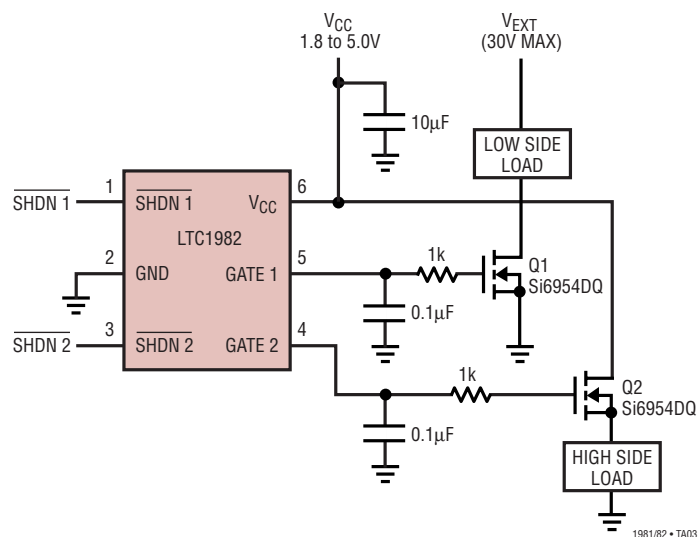5. PACKAGE EIAJ REFERENCE IS SC-74A (EIAJ)

7

TYPICAL APPLICATION

Driving Both High Side and Low Side Switches

1981/82 • TA03

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1153/LTC1154	Single High Side Micropower MOSFET Drivers	Circuit Breaker with Auto Reset
LTC1155/LTC1255	Dual High Side Micropower MOSFET Drivers	Latchoff Current Limit
LTC1163/LTC1165	Triple 1.8V to 6V High Side MOSFET Driver	Three MOSFET Drivers in 8-Lead SO Package
LTC1623	SMBus Dual High Side Switch Controller	Uses External Switches, Two Three-State Address Pins
LTC1710	SMBus Dual Monolithic High Side Switch	Uses Internal Switches, One Three-State Address Pin

Linear Technology Corporation
1630 McCarthy Blvd., Milpitas, CA 95035-7417
(408)432-1900 • FAX: (408) 434-0507 • www.linear-tech.com

sn19812 19812fs LT/LCG 1200 4K • PRINTED IN USA

© LINEAR TECHNOLOGY CORPORATION 2000